

P40B6SLK

Power MOSFETs
60V, 40A, N-channel

Feature

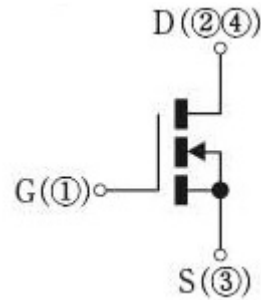
- N-channel
- SMD
- Low Ron
- 4.5V Gate Drive
- Low Capacitance
- Based on AEC-Q101
- Halogen free • Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): FB
Package (JEDEC Code): TO-252AA



Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	T _{stg}		-55 to 175	°C
Channel temperature	T _{ch}		-55 to 175	°C
Drain-source voltage	V _{DSS}		60	V
Gate-source voltage	V _{GSS}		±20	V
Continuous drain current(DC)	I _D		40	A
Continuous drain current(Peak)	I _{DP}	Pulse width 10μs, duty=1/100	120	A
Continuous source current(DC)	I _S		40	A
Total power dissipation	P _T	With heatsink※	46	W
Total power dissipation	P _T	Measured on the 1 inch ² glass epoxy substrate pattern area : 586.81mm ²	3.3	W
Total power dissipation	P _T	Measured on the 1 inch ² glass epoxy substrate pattern area : 102.19mm ²	2	W
Single avalanche current	I _{AS}	Starting T _{ch} =25°C T _{ch} ≤150°C	23	A
Single avalanche energy	E _{AS}	Starting T _{ch} =25°C T _{ch} ≤150°C	54	mJ

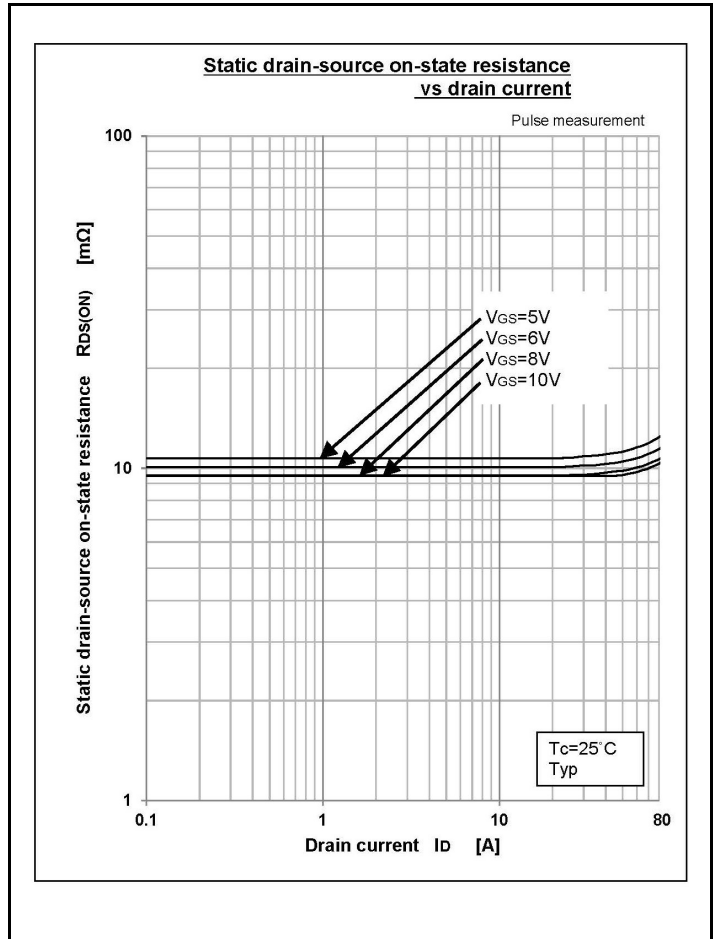
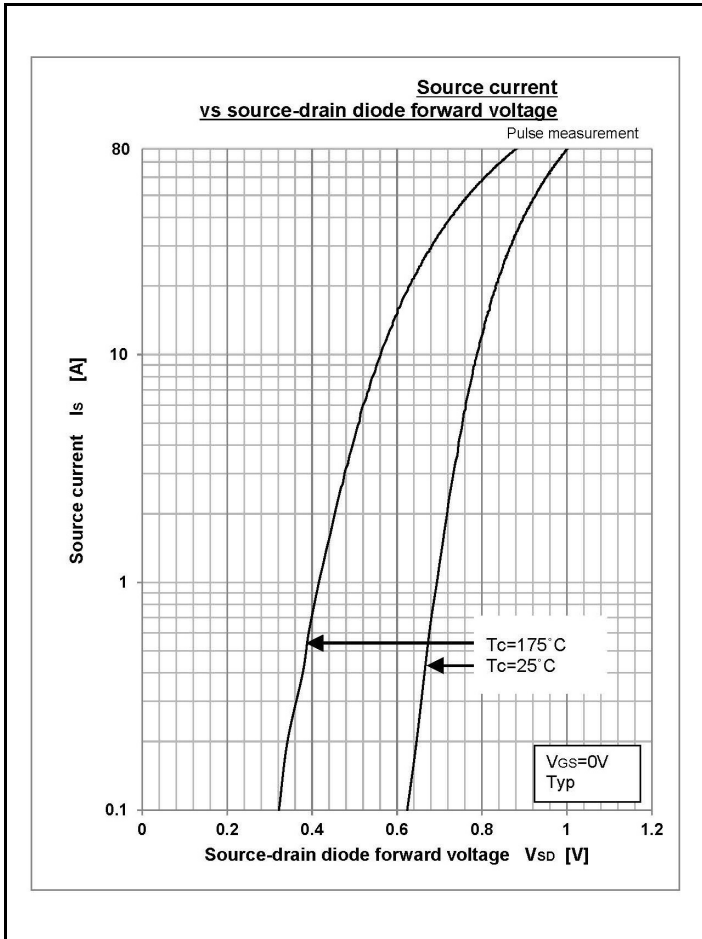
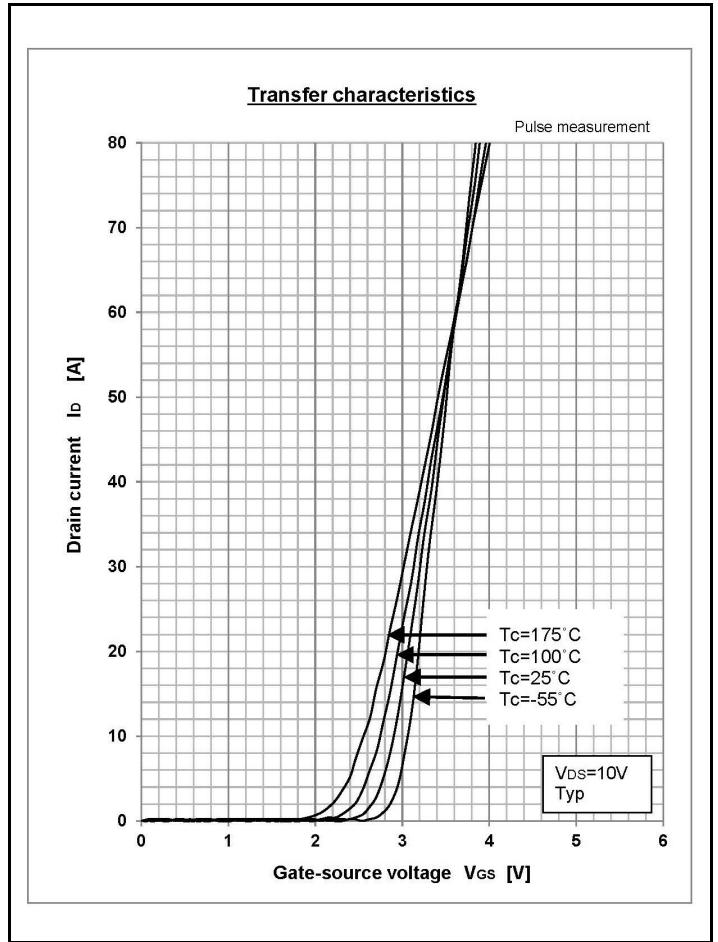
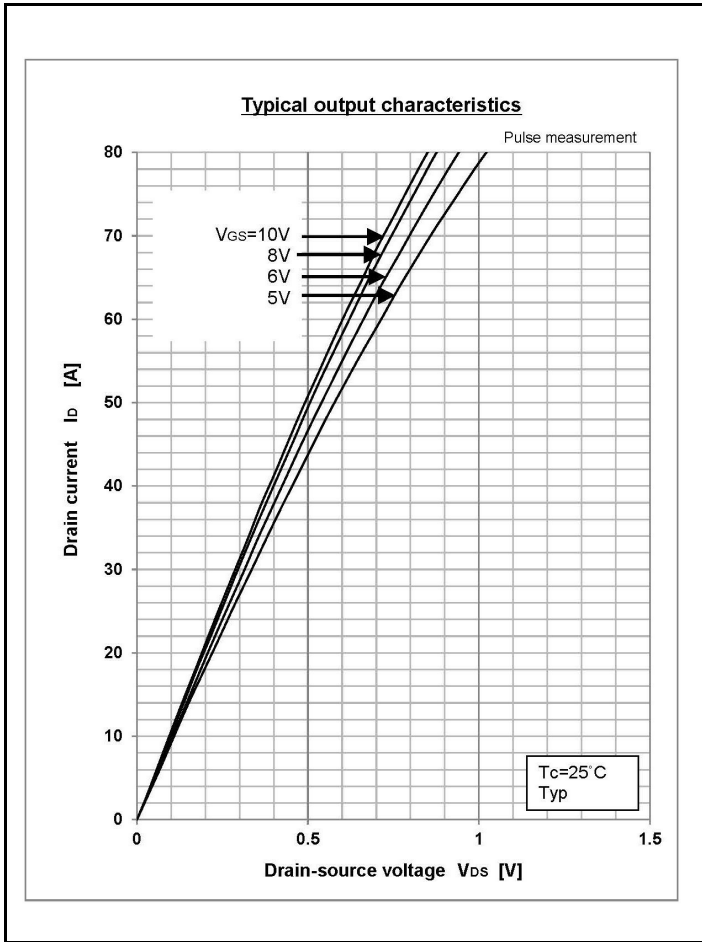
※ :See the original Specifications

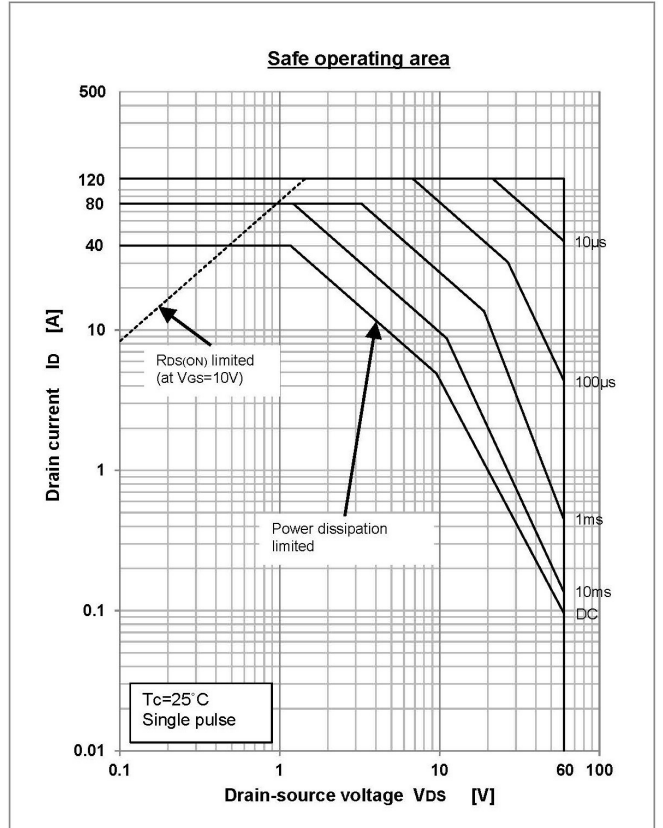
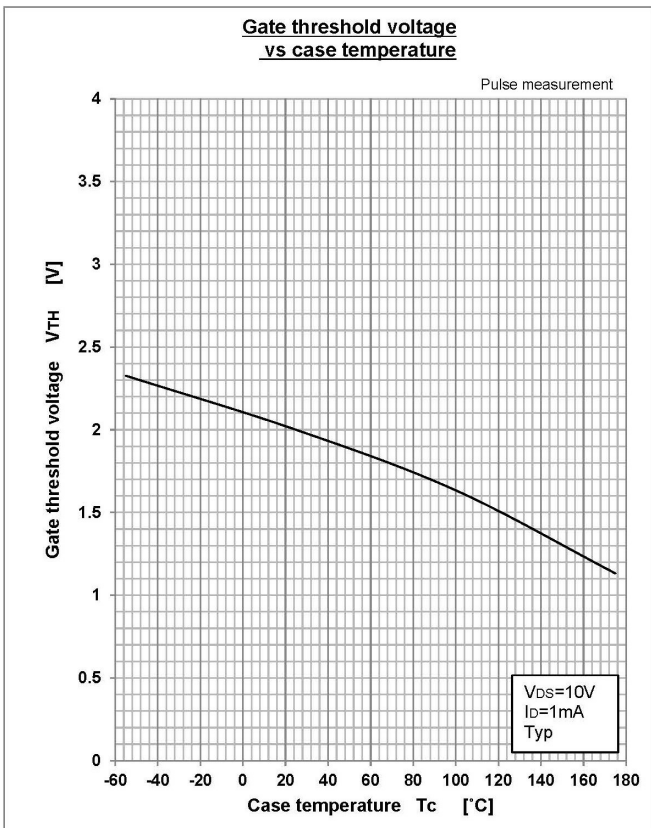
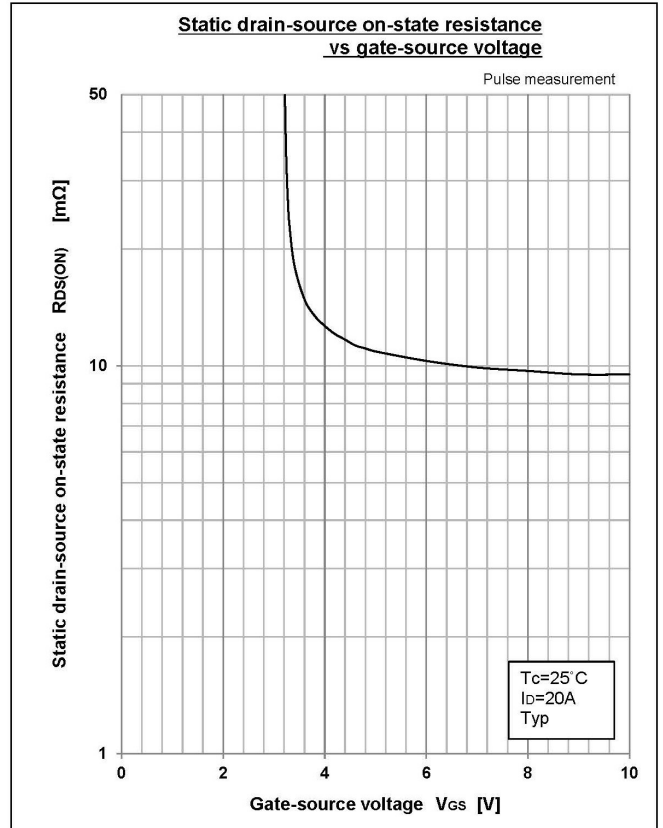
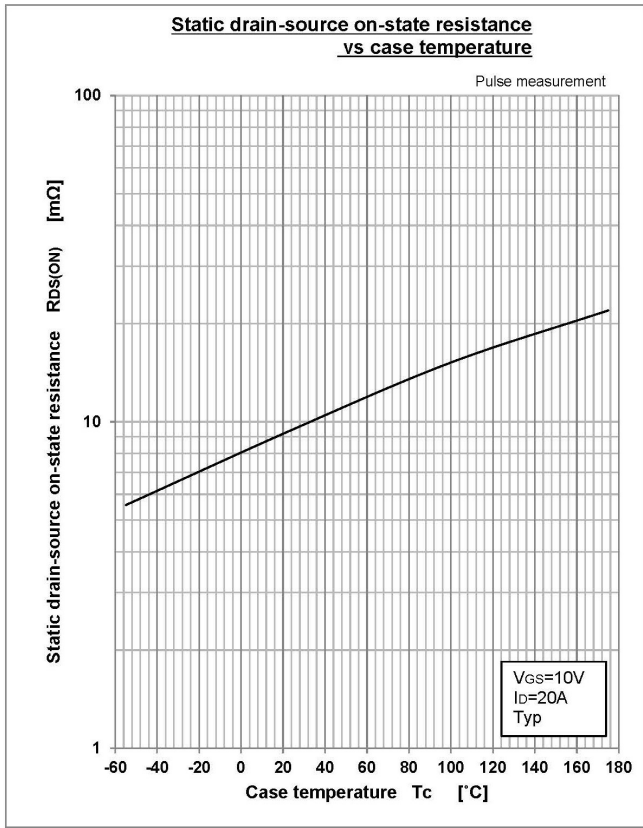
Electrical Characteristics (unless otherwise specified : Tc=25°C)

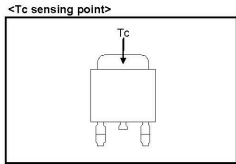
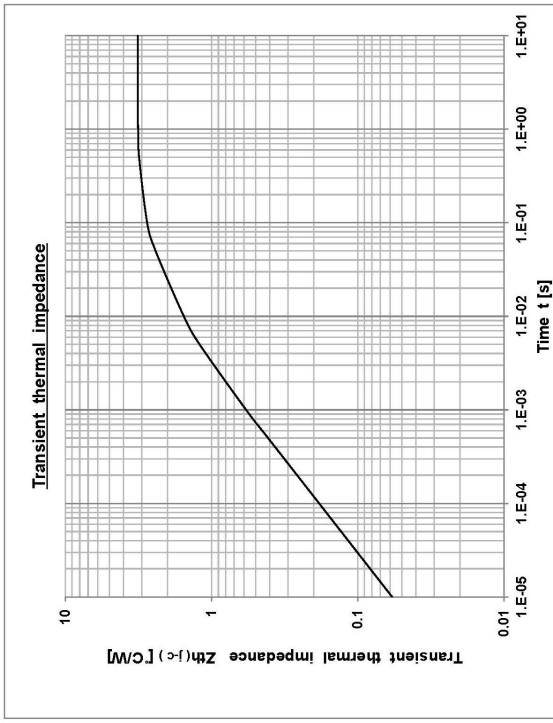
Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Drain-Source breakdown voltage	$V_{(BR)DSS}$	ID=1mA, VGS=0V	60			V
Zero gate voltage drain current	I_{DSS}	VDS=60V, VGS=0V			1	μA
Gate-source leakage current	I_{GSS}	VGS=±20V, VDS=0V			±0.1	μA
Forward transconductance	g_{fs}	ID=20A, VDS=10V	9			S
Static drain-source on-state resistance	$R_{DS(ON)}$	ID=20A, VGS=10V		0.0095	0.012	Ω
Static drain-source on-state resistance	$R_{DS(ON)}$	ID=20A, VGS=4.5V		0.012	0.016	Ω
Gate threshold voltage	Vth	ID=1mA, VDS=10V	1.5	2	2.5	V
Source-drain diode forward voltage	V_{SD}	IS=40A, VGS=0V			1.5	V
Thermal resistance	$R_{th(j-c)}$	Junction to case, with heatsink ※			3.2	°C/W
Thermal resistance	$R_{th(j-a)}$	Junction to ambient Measured on the 1 inch ² glass epoxy substrate pattern area : 586.81mm ²			45	°C/W
Thermal resistance	$R_{th(j-a)}$	Junction to ambient Measured on the 1 inch ² glass epoxy substrate pattern area : 102.19mm ²			75	°C/W
Total gate charge	Qg	VDD=48V, VGS=10V, ID=40A		43		nC
Gate to source charge	Qgs	VDD=48V, VGS=10V, ID=40A		8.5		nC
Gate to drain charge	Qgd	VDD=48V, VGS=10V, ID=40A		10		nC
Input capacitance	Ciss	VDS=25V, VGS=0V, f=1MHz		2050		pF
Reverse transfer capacitance	Crss	VDS=25V, VGS=0V, f=1MHz		110		pF
Output capacitance	Coss	VDS=25V, VGS=0V, f=1MHz		216		pF
Turn-on delay time	td(on)	ID=20A, RL=1.5Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		6		ns
Rise time	tr	ID=20A, RL=1.5Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		18		ns
Turn-off delay time	td(off)	ID=20A, RL=1.5Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		29		ns
Fall time	tf	ID=20A, RL=1.5Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		17		ns
Diode reverse recovery time	trr	IF=40A, VGS=0V, di/dt=100A/μs		42		ns
Diode reverse recovery charge	Qrr	IF=40A, VGS=0V, di/dt=100A/μs		51		nC

※ :See the original Specifications

CHARACTERISTIC DIAGRAMS



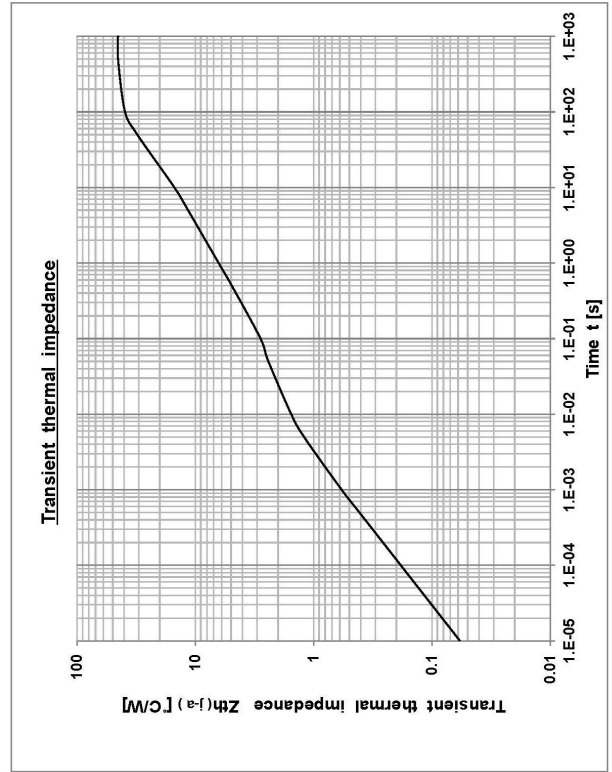




<Substrate detail>

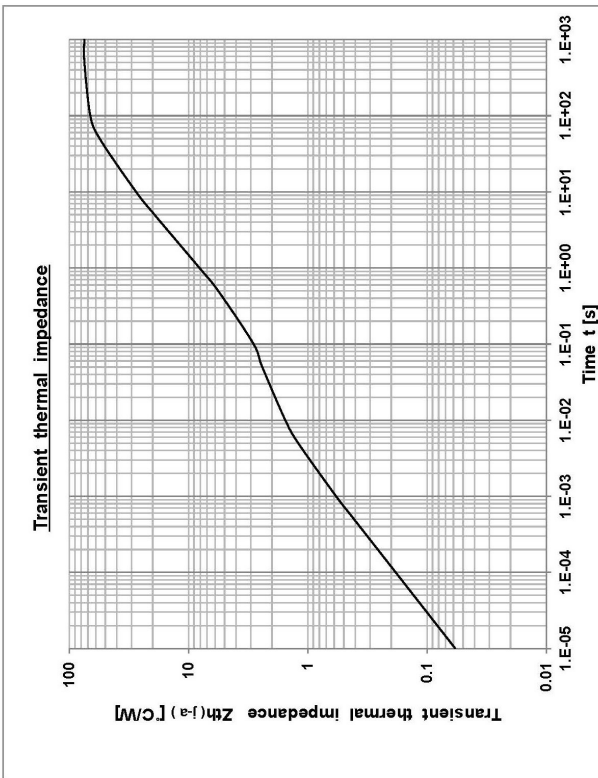
Type	Alumina
Size	1 inch ²
Thickness	0.84 mm
Conductor thickness	20 μm
Pattern area	65 mm ²

Specification No.



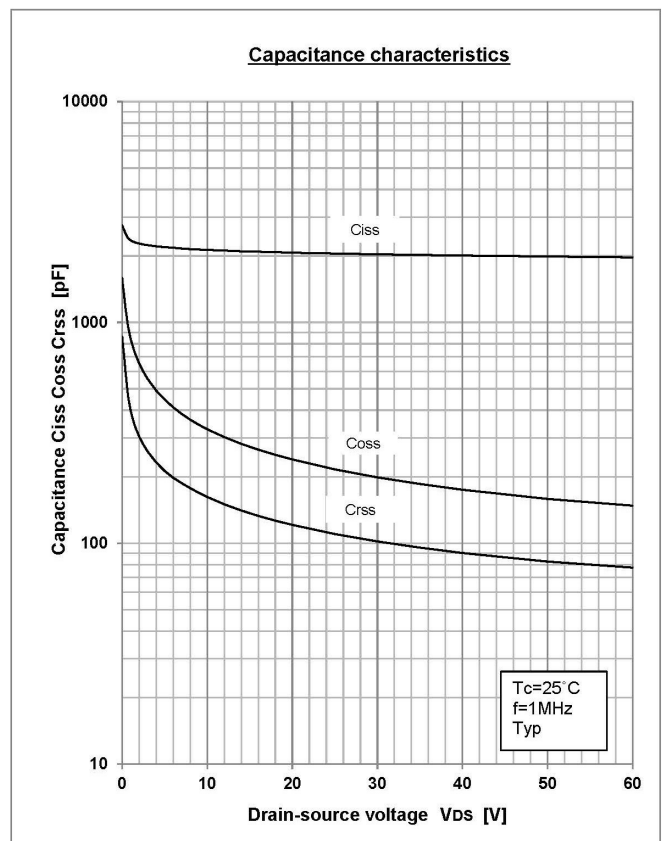
<Substrate detail>

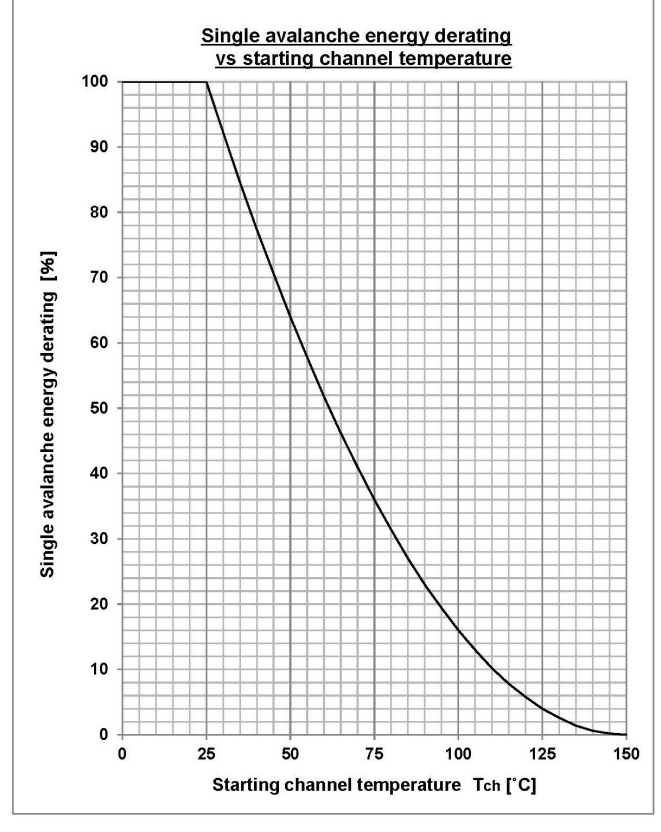
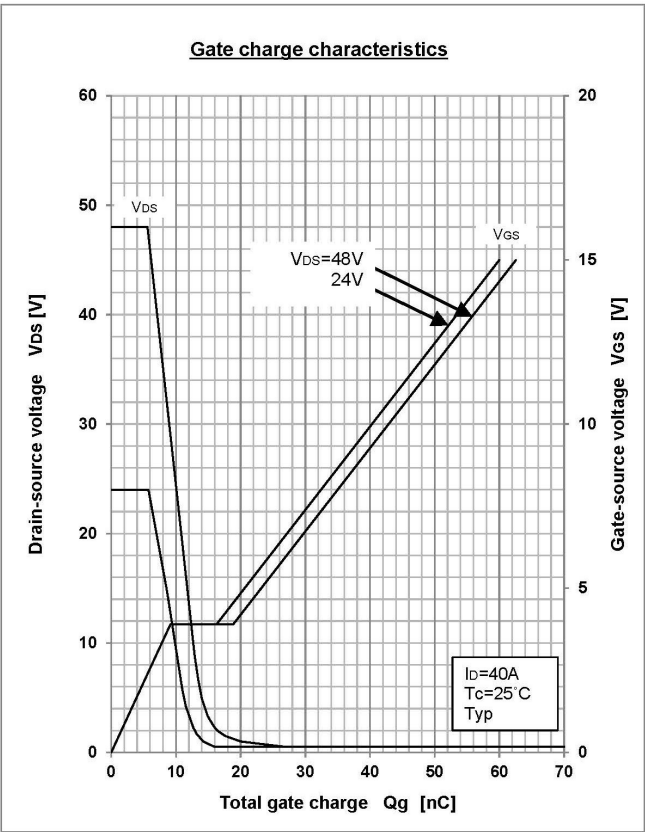
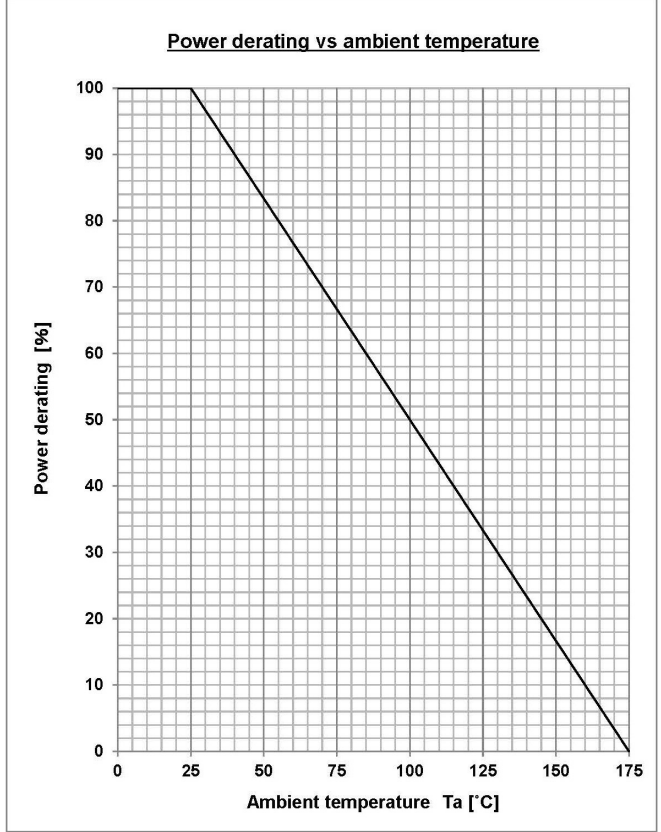
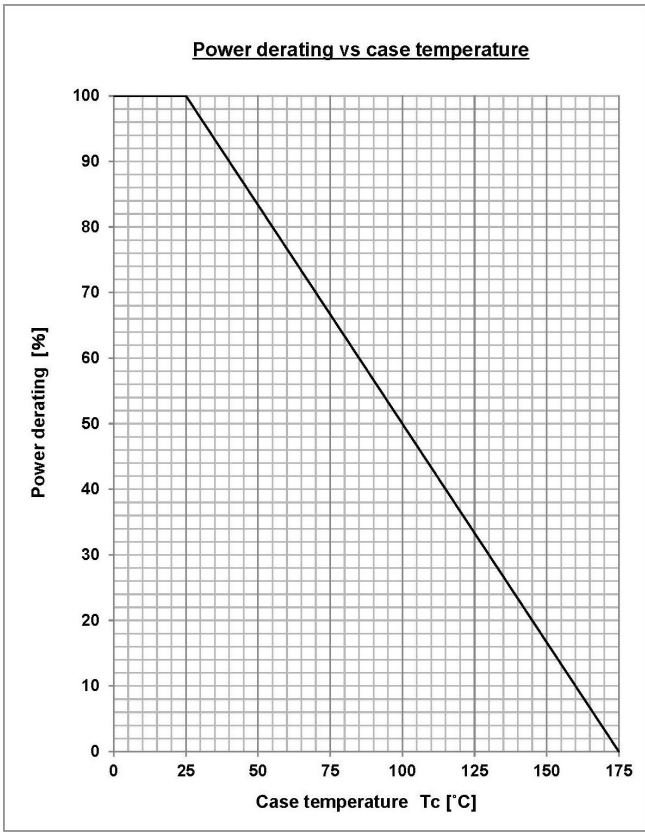
Type	Glass-epoxy
Size	1 inch ²
Thickness	1.6 mm
Conductor thickness	70 μm
Pattern area	586.81 mm ²



<Substrate detail>

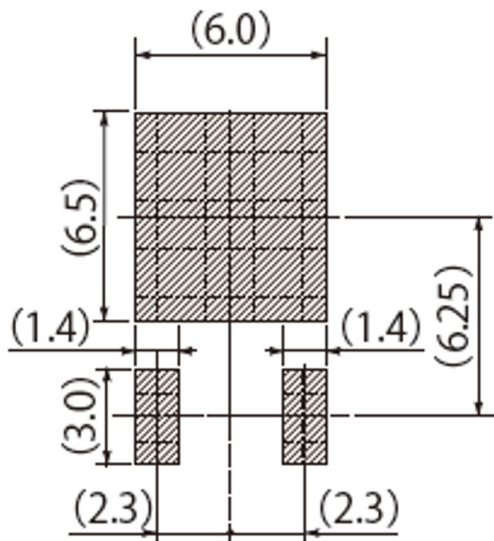
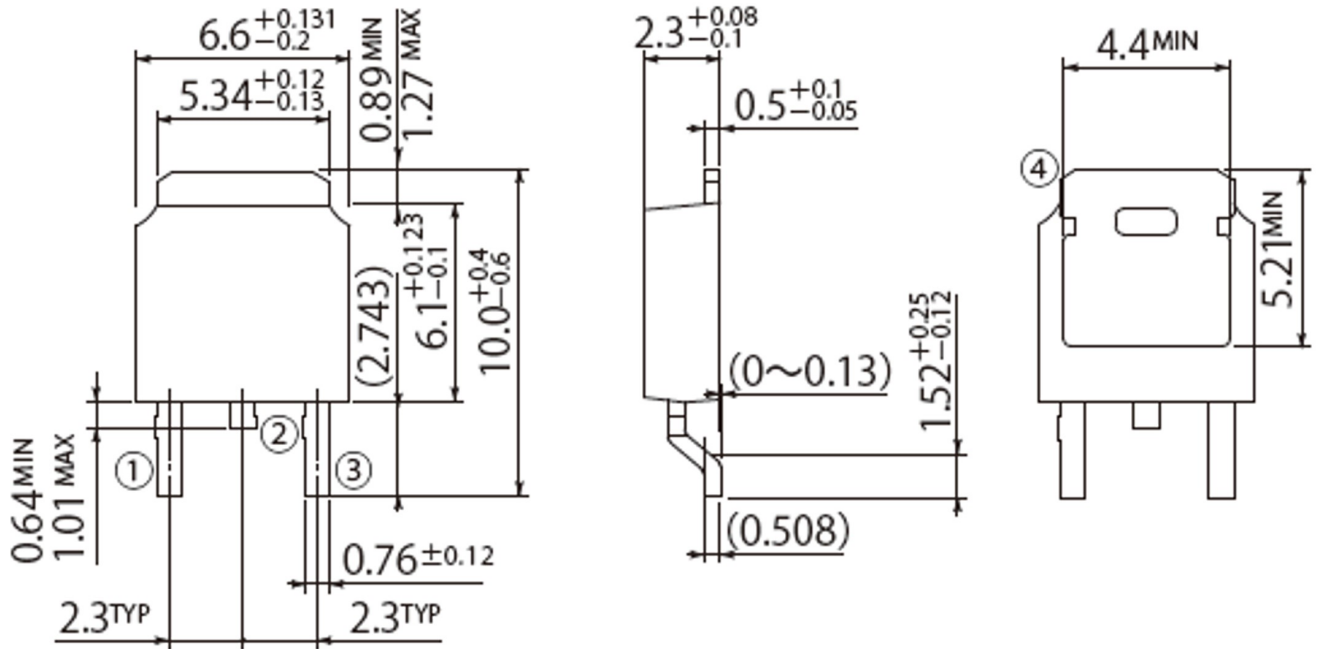
Type	Glass-epoxy
Size	1 inch ²
Thickness	1.6 mm
Conductor thickness	70 μm
Pattern area	102.19 mm ²





G2

JEDEC Code	TO-252AA
JEITA Code	-
House Name	FB



Referential Soldering Pad

Notes

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